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Volume 22 Number 1

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The International Journal of ENGINEERING EDUCATION

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Published 6 per annum

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The International Journal of ENGINEERING EDUCATION

AIMS AND SCOPE

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Cabello *et al.*—Infrared Thermography as a Useful Tool to Improve Learning in Heat Transfer Subjects

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Witt, Giralt *et al.*—A Competency-Based Educational Model in a Chemical Engineering School

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